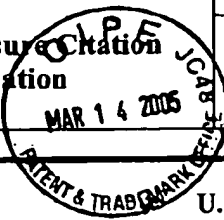


PTO-1449	Application No. 10/649,925		Applicant(s) Kovacevic et al.	
	Docket Number 021791.0109	Group Art Unit 2125	Filing Date 08/25/2003	

Information Disclosure
In an Application



U.S. PATENT DOCUMENTS

	DOCUMENT NO.	DATE	NAME	CLASS	SUBCLASS	FILING DATE
CK A	6,122,564	09/19/2000	Koch et al.	700	123	06/30/1998
CK B	6,188,041	02/13/2001	Kim et al.	219	121.63	11/13/1998
CK C	6,311,099	10/30/2001	Jasper et al.	700	166	10/15/1998
CK D	6,401,001	06/04/2002	Jang et al.	700	118	07/22/1999
CK E	6,459,951	10/01/2002	Griffith L.	700	166	09/10/1999
CK F	6,526,327	02/25/2003	Kar et al.	700	119	12/07/2000
CK G	6,638,787	10/28/2003	Buchin et al.	438	75	12/04/2001
CK H	US 2004/0107019	06/03/2004	Keshavmurthy et al.	700	118	07/18/2003
I						
J						
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M						
N						

FOREIGN PATENT DOCUMENTS

	DOCUMENT NO.	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
CK O		07/06/1999	Japan	B23K	26/02	XX	
CK P	WO 03/070414 A1	08/28/2003	PCT	B23K	26/03	XX	
Q							

	OTHER DOCUMENTS (Including Author, Title, Source, and Pertinent Pages)	DATE
R		
S		
T		

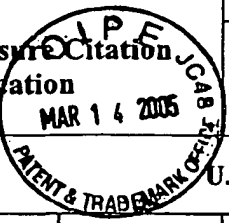
EXAMINER

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EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.

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PTO-1449		Application No. 10/649,925		Applicant(s) Kovacevic et al.	
Information Disclosure Citation In an Application 		Docket Number 021791.0109		Group Art Unit 2125	
		Filing Date Aug. 25, 2003			

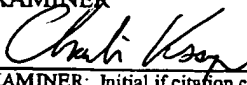
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CK	A	6,391,251	05/21/02	Keicher et al.	419	7	05/09/2000
CK	B	6,580,959	06/17/2003	Mazumder	700	121	05/19/2000
	C						

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CK	E	B. Grünenwald et al., "New Technological Developments in Laser Cladding", Proceedings of the International Congress on Applications of Lasers and Electro-Optics (ICALEO 1993), pp. 934-944.					1993
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CK	L	Dongming Hue et al., "Sensing, Modeling and Control for Laser-Based Additive Manufactures", International Journal of Machine Tools & Manufacture 43 (2003) pp. 51-60					2003
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